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# 3M™ Thermally Conductive Silicone Interface Pad 5584

#### **Product Description**

3M™ Thermally Conductive Silicone Interface Pad 5584 is designed to provide a preferential heat transfer path between heat generating components and heat sinks, heat spreaders or other cooling devices. 3M pad 5584 consists of a highly conformable and slightly tacky silicone elastomeric sheet filled with thermally conductive ceramic particles that provide enhanced thermal conductivity and excellent electrical insulation performance.

### **Key Features**

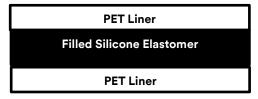
- Good softness and conformability even to non-flat surfaces
- · Good thermal conductivity
- Good electrical insulation properties
- Compression relaxation properties helps reduce pressure to electric components
- Slight tack allows pre-assembly
- Good wettability for improved and lower thermal resistance

### **Product Construction/Material Description**

**Note:** The following technical information and data should be considered representative or typical only and should not be used for specification purposes.

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3M™ Thermally Conductive Silicone Interface Pad 5584		
Property	Value	
Color	White	
Base resin	Silicone	
Thickness	0.5 - 2.0 mm*	
Primary filler	Ceramic	
Product liner	PET Film Liners	

<sup>\*</sup> Standard thickness range. Custom thickness options available up to 10 mm. Contact your local 3M Technical Representative for more information.



## **Applications**

- Integrated circuit (IC) chip packaging heat conduction
- Heat sink interface
- Chip on film (COF) heat conduction
- LED board thermal interface material (TIM)
- HD TV IC chip
- General gap filling in electronic devices

# 3M<sup>™</sup> Thermally Conductive Silicone Interface Pad 5584 Application Techniques

Substrate surfaces should be clean and dry prior to the thermal pad application to ensure best thermal performance. A clean surface can improve the thermal performance of an application.

- Isopropyl alcohol (isopropanol) applied with a lint-free wipe or swab should be adequate for removing surface
  contamination such as dust or fingerprints. Do not use "denatured alcohol" or glass cleaners, which often
  contain oily components. Allow the surface to dry for several minutes before applying the thermal pad. More
  aggressive solvents (such as acetone, methyl ethyl ketone (MEK) or toluene) may be required to remove heavier
  contamination (such as grease, machine oils, solder flux) but should be followed by a final isopropanol wipe as
  described above.
  - Note: Be sure to read and follow the manufacturers' precautions and directions when using solvents.
- Apply the thermal pad to one substrate at a modest angle with the use of a squeegee, rubber roller or finger
  pressure to help reduce the potential for air entrapment under the thermal pad during its application.
- Remove the release liner before application.
- Assemble the part by applying compression to the substrates to ensure a good wetting of the substrate surfaces
  with the thermal pads. Rigid substrates are more difficult to assemble without air entrapment as most rigid parts
  are not flat. Flexible substrates can be assembled to rigid or flexible parts with much less concern about air
  entrapment because one of the flexible substrate can conform to the other substrates during application.

### **Typical Physical Properties and Performance Characteristics**

**Note:** The following technical information and data should be considered representative or typical only and should not be used for specification purposes. Final product specifications and testing methods will be outlined in the products Certificate of Analysis (COA) that is shipped with the product.

3M™ Thermally Conductive Silicone Interface Pad 5584			
Property	Methoda	Value	
Thermal Conductivity (W/m-K)	ASTM D5470	1.1 W/m-K	
Density (g/cm³, @ 25°C)	ASTM D6111	1.9	
Operating Temperature Range Long Term (Weeks-Months) Short Term (Hours-Days)	3M test method	-50°C to 125°C -50°C to 160°C	
Shore 00 <sup>b</sup>	Modified ASTM D2240	40 ~ 50	
Dielectric Breakdown	Modified ASTM D149 (3M test method)	7 KV/mm	
Volume Resistivity	ASTM D257	3 x 10 <sup>12</sup> Ohms	

<sup>&</sup>lt;sup>a</sup>Methods listed as ASTM are tested in accordance with the ASTM method, or a modified version of the test noted

## Storage and Shelf Life

The shelf life of 3M<sup>™</sup> Thermally Conductive Silicone Interface Pad 5584 is 12 months from the date of manufacture when stored in the original packaging materials and stored at 21°C (70°F) and 50% relative humidity.

## **Certificate of Analysis (COA)**

The 3M Certificate of Analysis (COA) for this product is established when the product is commercially available from 3M and is shipped with the product. The COA contains the 3M specifications and test methods for the products performance limits that the product will be supplied against. The 3M product is supplied to 3M COA test specifications and the COA test methods. Contact your 3M Technical Representative for the COA for this product. This technical data sheet may contain preliminary data that is not within the COA specification limits and/or test methods used for COA purposes.

bShore 00 results depend on test method and thickness of the sample tested. Typical results are in the 40-50 Shore 00 range @ 6 mm test thickness. Ask your 3M Technical Representative for more details on pad softness.

# 3M™ Thermally Conductive Silicone Interface Pad 5584

Regulatory: For regulatory information about this product, contact your 3M representative.

**Technical Information:** The technical information, recommendations and other statements contained in this document are based upon tests or experience that 3M believes are reliable, but the accuracy or completeness of such information is not guaranteed.

**Product Use:** Many factors beyond 3M's control and uniquely within user's knowledge and control can affect the use and performance of a 3M product in a particular application Given the variety of factors that can affect the use and performance of a 3M product, user is solely responsible for evaluating the 3M product and determining whether it is fit for a particular purpose and suitable for user's method of application.

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